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IRT Nanoelec and its

CHARACTERIZATION program

November 24, 2020



7 edition



































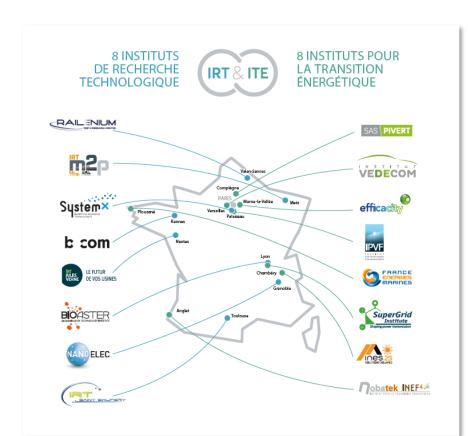






IRT & ITE: a set of consortium dedicated to R&D and innovation ARAGO







Vision and mission



> Address the main societal challenges by facilitating the link between technologies and applications

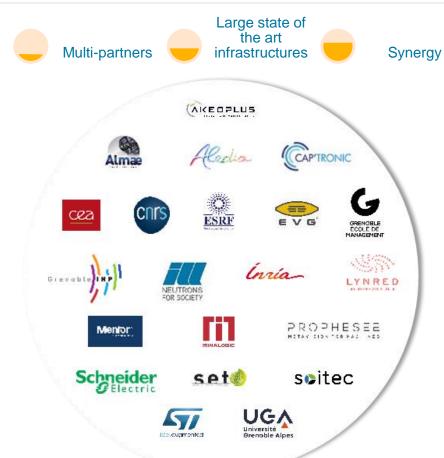
> Create value for the industrials partners to help them grow and address new markets, by fostering multipartners R&D programs





Current Nanoelec partners







11 industrial partners

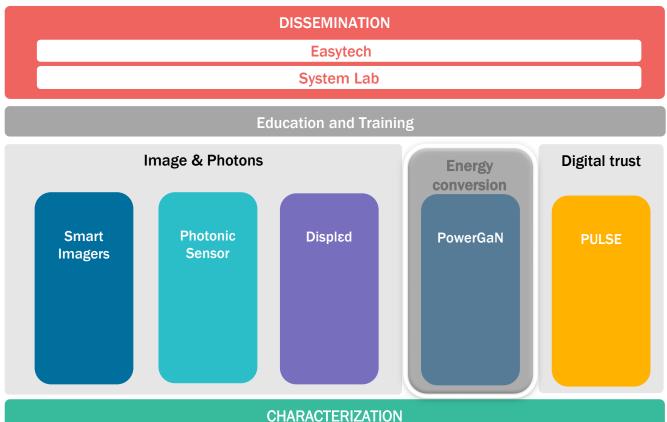
8 academics

1 pôle de compétitivité

1 association

2021 – 2025 : Nanoelec programs for the coming years





Nanoelec in a few figures (2019)



- > 22 core partners
- > 238 Associated partners since 2012, 85 of them being active in 2019
- > 54M€ mean budget on the 2015-2018 period (60,1 M€ in 2019)
- > 219 Full time positions engaged on our programs on the 2015-2019 period (269 in 2019)
- >4 new companies
- > 173 patents et 36 software filled (2019: 35 patents, 16 software)
- > 394 scientific publications & communications since 2015 (122 in 2019)



Large scale instruments characterization program



> Bringing together the local characterization ecosystem to address the industry needs



> Current industrial partners







> Partners under discussion







Large scale instruments characterization



Further develop the **physical** characterization service offer on our facilities to better serve the new stakes of the nanoelectronic industry

Objective 2

Set-up a brand new and unique state of the art irradiation competence center



Markets

- **Autonomous** transportation
- Medical
- **Spatial**
- **Data Centers**
- IoT

CNRS/LPSC











Irradiation competence center



Complementary facilities and skills driven by the needs of European industry



Coordination of other partner irradiation installation in Europe

Focused

Pulsed X-rays



Industrial and

private partners

14Mev et 2.5 MeV

NANOELEC.

Low energy

neutrons

(Thermal)



FOR SOCIETY

High energy



Expertise from academics and RT0s







PFNC

A structure fully dedicated to the electronic components reliability to irradiation

Extremely Brilliant Source

PAC-G: the offer to industry



STRESS AND STRAIN MEASUREMENT

Revealing stress and strain evolution during manufacture and use.

PROCESS MONITORING

In-situ process characterisation and optimisation of processing conditions.

CRYSTAL QUALITY DETERMINATION

Applications in qualification, wafer characterisation and new process development.

HIGH RESOLUTION IMAGING

Imaging electronic components in 2D/3D down to nanometre resolutions for failure analysis.

INTERFACE CHARACTERISATION

Probing buried interfaces to evaluate manufacturing processes, analyse failure and delamination.

IRRADIATION STUDIES

Investigating reliability and SEE sensitivity of electronic components and systems.

- Not only addressing microelectronics industry needs:
 - Material science
 - Welding
 - Process control
 - Other domains



0 • Carac'20 November 24, 2020

Coming next month







Thank you for your attention



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